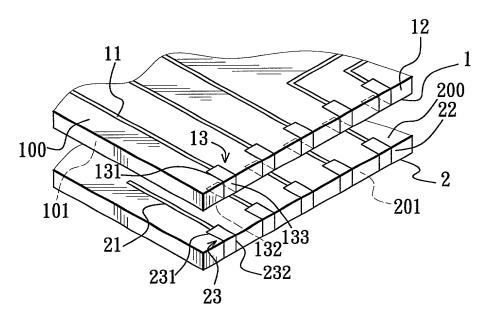
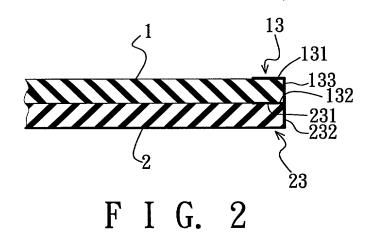
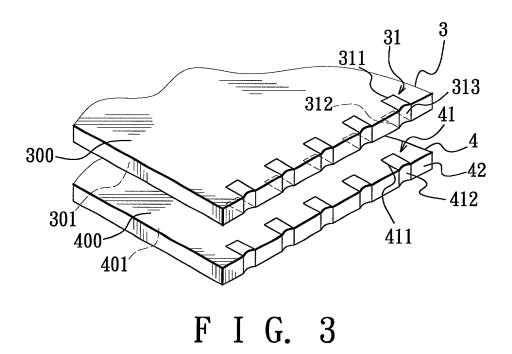
Inventor: CHENG et al.
Docket No.: 8688.258US01
Title: METHOD OF FABRICATING A MULTI-LAYER CIRCUIT BOARD ASSEMBLY
Attorney Name. Michael D. Schumann
Phone No.: 612.336.4638
Sheet 1 of 3

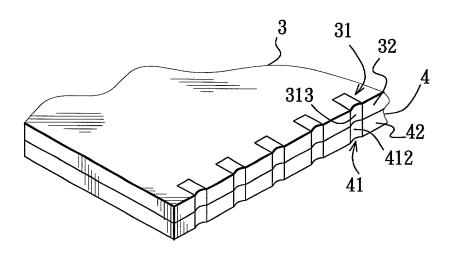


F I G. 1



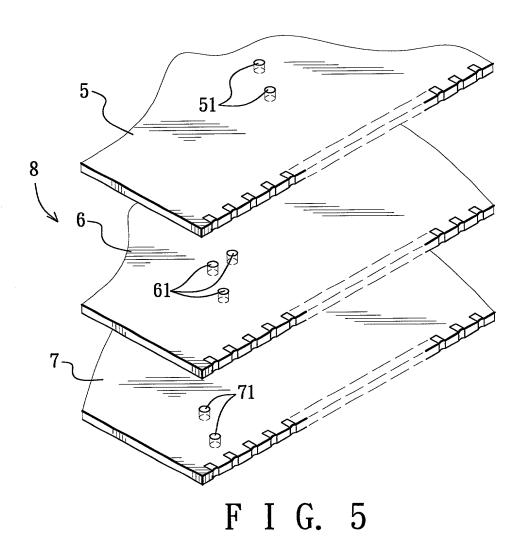
Inventor: CHENG et al.
Docket No.: 8688.258US01
Title METHOD OF FABRICATING A MULTI-LAYER CIRCUIT BOARD ASSEMBLY
Attorney Name Michael D. Schumann
Phone No.: 612 336 4638
Sheet 2 of 3

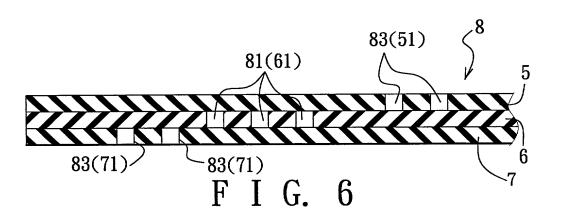




F I G. 4

Inventor: CHENG et al.
Docket No.: 8688.258US01
Title: METHOD OF FABRICATING A MULTI-LAYER CIRCUIT BOARD ASSEMBLY
Attorney Name. Michael D. Schumann
Phone No.: 612.336 4638
Sheet 3 of 3





13 122 1.2